

## Advance Technical Information

# **High Current** MegaMOS™FET

**IXTK 250N10** 

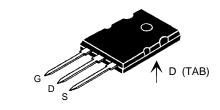
100  $5 \text{ m}\Omega$  $\boldsymbol{R}_{\text{DS(on)}}$ 

N-Channel Enhancement Mode



Symbol	Test conditions	Maximu	m ratings
V <sub>DSS</sub>	T <sub>J</sub> = 25°C to 150°C	100	V
$\mathbf{V}_{DGR}$	$T_J = 25$ °C to 150°C; $R_{GS} = 1.0 \text{ M}\Omega$	100	V
V <sub>gs</sub>	Continuous	±20	V
$\mathbf{V}_{GSM}$	Transient	±30	V
I <sub>D25</sub>	T <sub>c</sub> = 25°C MOSFET chip capability	250	Α
I <sub>D(RMS)</sub>	External lead current limit	75	Α
I <sub>DM</sub>	$T_{\rm C}$ = 25°C, pulse width limited by $T_{\rm JM}$	1000	Α
I <sub>AR</sub>	$T_{c}^{\circ} = 25^{\circ}C$	90	Α
E <sub>AR</sub>	T <sub>c</sub> = 25°C	80	mJ
Eas	$T_{c} = 25^{\circ}C$	4.0	J
dv/dt	$I_{S} \leq I_{DM}$ , di/dt $\leq$ 100 A/ $\mu$ s, $V_{DD} \leq V_{DSS}$ $T_{J} \leq$ 150°C, $R_{G} = 2 \Omega$	5	V/ns
$P_{D}$	$T_{c} = 25^{\circ}C$	730	W
T <sub>J</sub>		-55 <b>+</b> 150	°C
$T_{JM}$		150	°C
T <sub>stg</sub>		-55 <b>+</b> 150	°C
T <sub>L</sub>	1.6 mm (0.063 in.) from case for 10 s	300	°C
M <sub>d</sub>	Mounting torque	0.7/6	Nm/lb.in.
Weight	TO-264	10	g

### TO-264 AA (IXTK)



$$G = Gate$$
  $D = Drain$   $S = Source$   $Tab = Drain$ 

### **Features**

- $\bullet \mbox{Low R}_{\mbox{\tiny DS (on)}} \mbox{ HDMOS}^{\mbox{\tiny TM}} \mbox{ process} \\ \bullet \mbox{ Rugged polysilicon gate cell structure}$
- International standard package
- Fast switching times

• Motor controls

**Applications** 

- DC choppers
- Switched-mode power supplies
- DC-DC Converters
- Linear Regulators

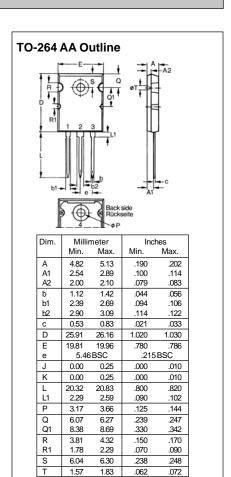
#### Advantages

- Easy to mount with one screw (isolated mounting screw hole)
- Space savings
- High power density

Symbol	<b>Test Conditions</b>		Characteristic Values			
$(T_J = 25^{\circ}C$	(T <sub>J</sub> = 25°C unless otherwise specified)		Min.	Тур.	Max.	
V <sub>DSS</sub>	$V_{GS} = 0 \text{ V}, I_{D} = 1 \text{ mA}$		100			V
V <sub>GS(th)</sub>	$V_{_{DS}} = V_{_{GS}}, I_{_{D}} = 250 \mu\text{A}$		2.0		4.0	V
I <sub>GSS</sub>	$V_{GS} = \pm 20 \text{ V DC}, V_{DS} = 0$				±200	nA
I <sub>DSS</sub>	$V_{DS} = V_{DSS}$ $V_{GS} = 0 V$	$T_J = 25$ °C $T_J = 125$ °C			50 1	μA mA
R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, I_{D} = 90 \text{ A}$ Pulse test, t \le 300 ms, duty cy	/cle d ≤ 2%			5	mΩ



Symbol Test Conditions C		naracteristic values		
(T <sub>J</sub> = 25°C unless otherwise specified)	Min.	Тур.	Max.	
$\mathbf{g}_{fs}$ $V_{DS} = 10 \text{ V}; I_{D} = 90 \text{ A, pulse test}$	75	110	S	
C <sub>iss</sub>		7800	pF	
$C_{oss}$ $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		3200	pF	
C <sub>rss</sub>		1300	pF	
t <sub>d(on)</sub>		35	ns	
$t_{r}$ $V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_{D} = 90 \text{ A}$		40	ns	
$t_{d(off)}$ $R_G = 1.0 \Omega \text{ (External)}$		120	ns	
t,		55	ns	
$Q_{g(on)}$		390	nC	
$Q_{gs}$ $V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_{D} = 0.5 I_{I}$	025	60	nC	
$\mathbf{Q}_{\mathrm{gd}}$		180	nC	
R <sub>thJC</sub>			0.17 K/W	
R <sub>thCK</sub>		0.15	K/W	



#### Source-Drain Diode

Ratings and Characteristics (T<sub>1</sub> = 25°C unless otherwise specified)

Symbol	Test Conditions	Min.	Тур.	Max.	•
I <sub>s</sub>	$V_{GS} = 0V$			250	Α
I <sub>sm</sub>	Repetitive; pulse width limited by $\rm T_{_{\rm JM}}$			1000	Α
$\mathbf{V}_{\mathtt{SD}}$	$I_F = 90$ A, $V_{GS} = 0$ V, Pulse test, $t \le 300$ µs, duty cycle d $\le 2$ %			1.2	V
t <sub>rr</sub>	$I_F = 30A$ , -di/dt = 100 A/ $\mu$ s, $V_R = 50 V$		150		ns
Q <sub>rr</sub>			2		μС